SBT BGA Socket - Direct mount, solderless



File: SBT-BGA-6019 Dwg.mcd

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*Note: BGA pattern is not symmetrical with respect to the mounting holes. It is offset 0.375mm to the right of the tooling holes.



Target PCB Recommendations

Total thickness: 3.175mm min. Plating: Gold or Solder finish

PCB Pad height: Same or higher than solder mask

NOTE: Steel backing plate may be required based on end user's application

Recommended PCB Layout Tolerances: ± 0.025 mm [± 0.001 "] unless stated otherwise.

SBT-BGA-6019 Drawing		Status: Released	Scale: -		Rev: A
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Compatible BGA Spec



Ironwood Package Code: BGA762A

- 1. Dimensions are in millimeters.
- 2. Interpret dimensions and tolerances per ASME Y14.5M-1994.

- Parallelism measurement shall exclude any effect of mark on top surface of package.

DIM	MIN	MAX		
А	1.41	1.69		
A1	0.40	0.6		
A2	0.36	0.42		
b	0.5	0.7		
D1	12.09			
E1	11.88			
D	29.0 BSC			
Е	29.0	BSC		
е	1.00 BSC			

Array 28 x 28

SBT-BGA-6019 Drawing	F-BGA-6019 Drawing Status: Released Scale: -		Rev: A		
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DETAIL 57/0.25ZA1 Z 4 0.20Z



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